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| Project | IEEE 802.20 Working Group on Mobile Broadband Wireless Access < http://ieee802.org/20/ > | |
| Title | MBTDD Wideband Mode Technology Overview Presentation | |
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| Re: | MBWA Call for Proposals | |
| Abstract | This single page contribution highlights a terminology change in a previous contribution (C802.20-05/64r1). No technical changes from previously presented materials in that contribution are proposed. Wherever the term QTDD is used in C802.20-05/64r1, the material should be read as applying to MBTDD Wideband Mode. This contribution incorporates all material from C802.20-05/64r1 with this single editorial change. | |
| Purpose | For consideration of 802.20 in its efforts to adopt a TDD proposal for MBWA. | |
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